506981245 11/16/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KARTIK IYER	12/11/2019
RADHAKRISHNAN IYER	12/11/2019
NAVEEN KUMAR M	12/11/2019

RECEIVING PARTY DATA

Name:	UIPATH, INC.
Street Address:	90 PARK AVENUE
Internal Address:	20TH FLOOR
City:	NEW YORK
State/Country:	NEW YORK
Postal Code:	10016

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17528150

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	1678.0008CIP
NAME OF SUBMITTER:	DIANA KERR
SIGNATURE:	/Diana Kerr/
DATE SIGNED:	11/16/2021

Total Attachments: 4

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PATENT 506981245 REEL: 058131 FRAME: 0232

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PATENT REEL: 058131 FRAME: 0233

ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS:

- (A) Kartik IYER, an Indian citizen residing in Karnataka, India;
- (B) Radhakrishnan IYER, an Indian citizen residing in Karnataka, India; and
- (C) Naveen KUMAR M, an Indian citizen residing in Karnataka, India,

(hereinafter referred to as ASSIGNOR(S)), have made a discovery and/or invention entitled:

AUTOMATIC COMPLETION OF ROBOTIC PROCESS AUTOMATION WORKFLOWS USING MACHINE LEARNING

for which the following provisional and/or nonprovisional patent application(s) have been filed:

Application No.:	Filing Date:	UiPath Reference No.:
US 16/702,966	December 4, 2019	190094
IN 201911041766	October 15, 2019	190094

WHEREAS:

UiPath, Inc., a United States Corporation, having its administrative offices located at 90 Park Avenue, 20th Floor, New York, NY 10016, United States of America,

and which, together with its successors, assigns, and legal representatives, is hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign, and transfer to ASSIGNEE the full and exclusive right, title, and interest to the invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for the invention by the application or any continuation, continuation-in-part, divisional, reexamination, reissue and/or any other application claiming priority thereof, including any legal equivalent thereof, in a foreign country for the full term or terms for which the same may be granted.

I/WE, SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for the invention to the ASSIGNEE, as assignee of the entire right, title, and interest in, to and under the same, for the sole use and benefit of the ASSIGNEE in accordance with the terms of this instrument.

I/WE, SAID ASSIGNOR(S), hereby covenant with ASSIGNEE that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been

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made to others by the undersigned and that I/we have full right to convey the entire right, title, and interest herein sold, assigned, transferred, and set over.

I/WE, SAID ASSIGNOR(S), hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on the invention and claim the benefits of the International Convention, and that I/we will, at any time, when called upon to do so by the ASSIGNEE, communicate to the ASSIGNEE as the case may be, any facts known to me respecting the invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the invention, the applications, and the Letters Patent in the ASSIGNEE, and that if reissues or reexaminations of the Letters Patent or disclaimers relating thereto, or divisionals, continuations, or continuations-in-part of the application shall hereafter be desired by the ASSIGNEE, I/we will, at any time, when called upon to do so by the ASSIGNEE, sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, continuation-inpart, reexamination, and reissue applications so desired, and do all lawful acts requisite for the application for such continuations, continuations-in-part, divisionals, reexaminations, or reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE to obtain and enforce proper patent protection for the invention in all countries, all without further compensation but at the expense of the ASSIGNEE.

I/WE, SAID ASSIGNOR(S), hereby authorize and request the prosecuting law firm to insert herein above the application number and filing date of said application when known.

executed this	Signature of Inventor(s)
12/11/2019	DocuSigned by:
day of , <u>2019</u>	Kartik IYER
	Karukttek
witnessed by	
Teodor Chirvase	Docusigned by: Veo Dov Chinnelse 29D7EE3D082F47B
UiPath Witness #1 Printed Name	Signature
Valentina Ditoiu	Valentina Ditoiu
UiPath Witness #2 Printed Name	Signature

executed this	Signature of Inventor(s)
12/11/2019	DocuSigned by:
day of , <u>2019</u>	Radhakrishnan 1yer 29508245922A41C Radhakrishnan IYER
	Nadianisiilaiiii EN
witnessed by	
Teodor Chirvase	Docusigned by: Veopor Chimase 29D7EE3D082F47B
UiPath Witness #1 Printed Name	Signature
	DocuSigned by:
Valentina Ditoiu	Valentina Vitoiu
UiPath Witness #2 Printed Name	Signature

executed this	Signature of Inventor(s)
12/11/2019	DocuSigned by:
day of , <u>2019</u>	Naveen Kumas M 2F3C01B51D3D4CB Naveen KUMAR M
witnessed by	
Teodor Chirvase	Docusigned by: VeoRov Chimkse 29D7EE3D082F47B
UiPath Witness #1 Printed Name	Signature
Valentina Ditoiu UiPath Witness #2 Printed Name	Valentina Ditoiu Signature
OIFAUT VVILLIESS #2 PHILLEU IVAILLE	Signature

RECORDED: 11/16/2021